

STARPOWER

SEMICONDUCTOR

MOSFET

MD50FFC120C5S

1200V/50A 6 in one-package

General Description

STARPOWER MOSFET Power Module provides very low $R_{DS(on)}$ as well as optimized intrinsic diode. It's designed for the applications such as SMPS and DC drives.

Features

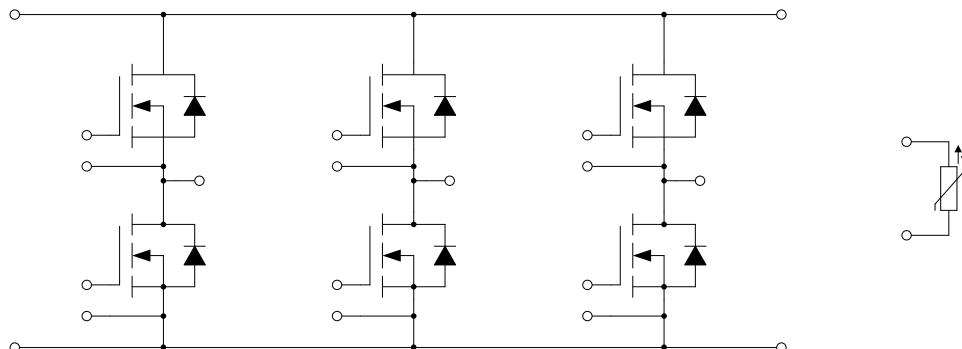
- SiC power MOSFET
- Low $R_{DS(on)}$
- Optimized intrinsic reverse diode
- Low inductance case avoid oscillations
- Kelvin source terminals for easy drive
- Isolated copper baseplate using DBC technology



Typical Applications

- Main and auxiliary AC drives of electric vehicles
- DC servo and robot drives
- Battery vehicles
- Plasma cutting

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**MOSFET**

Symbol	Description	Value	Unit
V_{DSS}	Drain-Source Voltage	1200	V
V_{GSS}	Gate-Source Voltage	-10/+25	V
I_D	Drain Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=100^{\circ}\text{C}$	86	A
		50	
I_{DM}	Pulsed Drain Current	250	A
P_D	Maximum Power Dissipation @ $T_j=150^{\circ}\text{C}$	297	W

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	50	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	250	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	150	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +125	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	2500	V

MOSFET Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$R_{DS(on)}$	Static Drain-Source On-Resistance	$I_D=50\text{A}, V_{GS}=18\text{V}, T_j=25^\circ\text{C}$		25.0	34.0	$\text{m}\Omega$
		$I_D=50\text{A}, V_{GS}=18\text{V}, T_j=150^\circ\text{C}$		43.0		
$V_{GS(th)}$	Gate-Source Threshold Voltage	$I_D=12.5\text{mA}, V_{DS}=20\text{V}, T_j=25^\circ\text{C}$	2.4	3.0		V
g_{fs}	Forward Transconductance	$V_{DS}=20\text{V}, I_D=50\text{A}, T_j=25^\circ\text{C}$		23.6		S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=V_{DSS}, V_{GS}=0\text{V}, T_j=25^\circ\text{C}$			0.1	mA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0\text{V}, T_j=25^\circ\text{C}$			500	nA
R_{Gint}	Internal Gate Resistance			1.50		Ω
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=800\text{V}, f=1.0\text{MHz}$		2.80		nF
C_{oss}	Output Capacitance			0.39		nF
C_{rss}	Reverse Transfer Capacitance			0.02		nF
Q_g	Total Gate Charge	$I_D=50\text{A}, V_{DS}=800\text{V}, V_{GS}=-5/20\text{V}$		178		nC
Q_{gs}	Gate-Source Charge			35		nC
Q_{gd}	Gate-Drain ("Miller") Charge			32		nC
$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=800\text{V}, I_D=50\text{A}, R_G=2.5\Omega, V_{GS}=-5/20\text{V}, T_j=25^\circ\text{C}$		15		ns
t_r	Rise Time			31		ns
$t_{d(off)}$	Turn-Off Delay Time			30		ns
t_f	Fall Time			27		ns
E_{on}	Turn-On Switching Loss				1.4	
E_{off}	Turn-Off Switching Loss			0.3		mJ

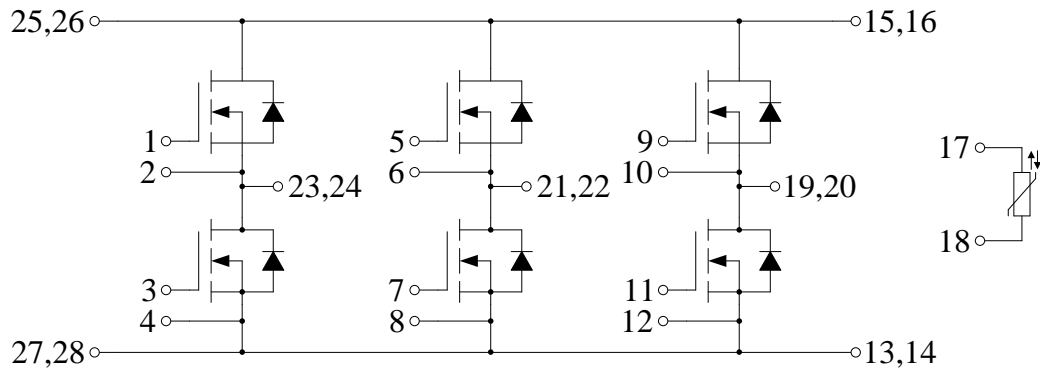
Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=50\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.50	1.70	V
		$I_F=50\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		2.00		

Module Characteristics $T_c=25^{\circ}\text{C}$ unless otherwise noted

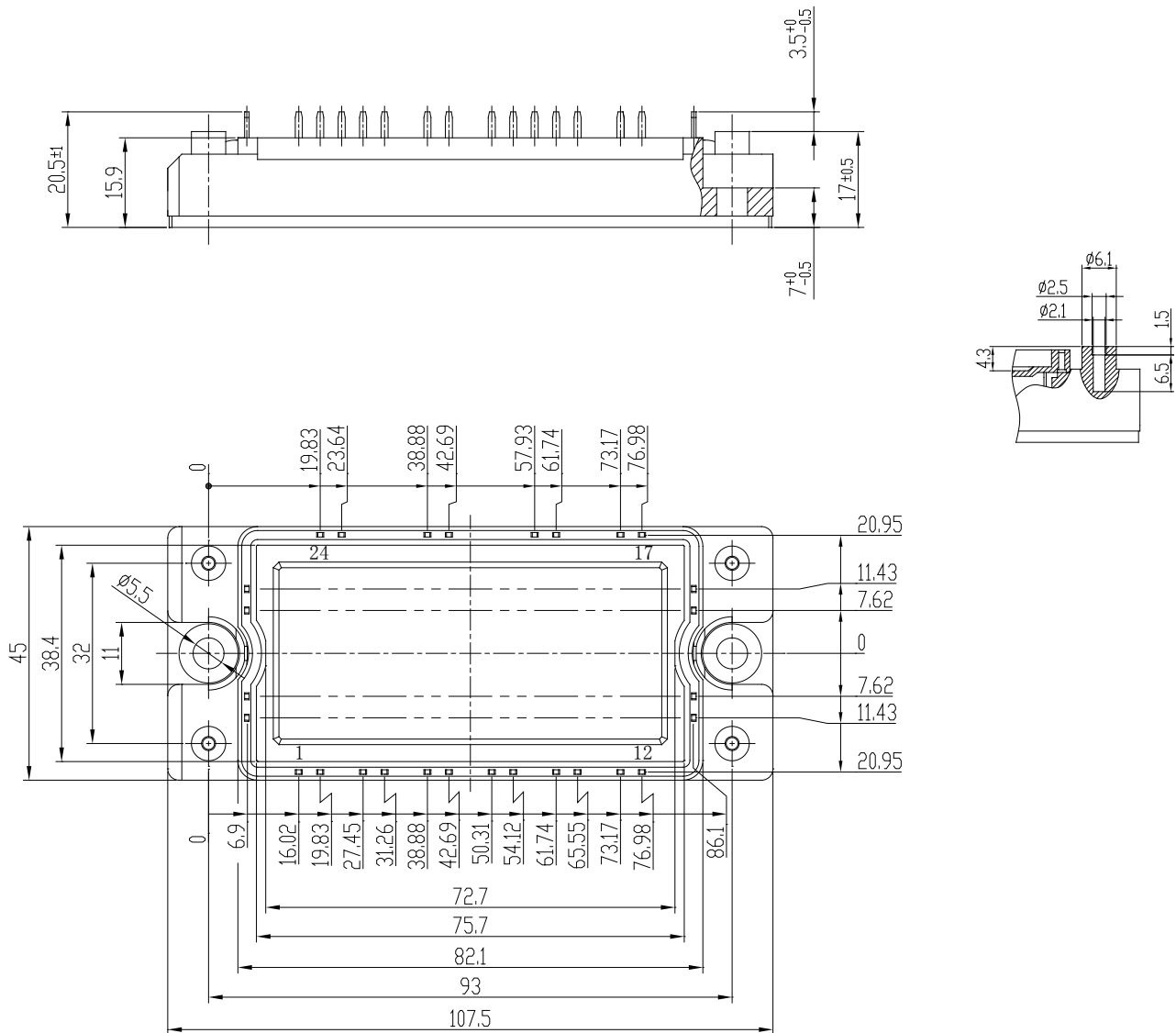
Symbol	Parameter	Min.	Typ.	Max.	Unit
R_{thJC}	Junction-to-Case(per MOSFET)			0.420	K/W
	Junction-to-Case(per Diode)			0.503	
R_{thCH}	Case-to-Heatsink (per Module)		0.020		K/W
M	Mounting Torque, Screw M5	3.0		6.0	N.m
G	Weight of Module		200		g

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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